

Edition 1.0 2009-06

# INTERNATIONAL STANDARD

Field device tool (FDT) interface specification –
Part 306: Communication profile integration – IEC 61784 CPF 6





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRICE CODE

ICS 25.040.40; 35.100.05; 35.110

ISBN 2-8318-1049-8

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# INTERNATIONAL ELECTROTECHNICAL COMMISSION

## FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION -

# Part 306: Communication profile integration – IEC 61784 CPF 6

#### **FOREWORD**

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International Standard IEC 62453-306 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This part, in conjunction with the other parts of the first edition of the IEC 62453 series cancels and replaces IEC/PAS 62453-1, IEC/PAS 62453-2, IEC/PAS 62453-3, IEC/PAS 62453-4 and IEC/PAS 62453-5 published in 2006, and constitutes a technical revision.

Each part of the IEC 62453-3xy series is intended to be read in conjunction with IEC 62453-2.

The text of this standard is based on the following documents:

FDIS	Report on voting
65E/129/FDIS	65E/142/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of the IEC 62453 series, under the general title *Field Device Tool (FDT) interface specification*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- · reconfirmed.
- · withdrawn,
- · replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

#### INTRODUCTION

This part of IEC 62453 is an interface specification for developers of FDT (Field Device Tool) components for function control and data access within a client/server architecture. The specification is a result of an analysis and design process to develop standard interfaces to facilitate the development of servers and clients by multiple vendors that need to interoperate seamlessly.

With the integration of fieldbusses into control systems, there are a few other tasks which need to be performed. In addition to fieldbus- and device-specific tools, there is a need to integrate these tools into higher-level system-wide planning- or engineering tools. In particular, for use in extensive and heterogeneous control systems, typically in the area of the process industry, the unambiguous definition of engineering interfaces that are easy to use for all those involved is of great importance.

A device-specific software component, called DTM (Device Type Manager), is supplied by the field device manufacturer with its device. The DTM is integrated into engineering tools via the FDT interfaces defined in this standard. The approach to integration is in general open for all kind of fieldbusses and thus meets the requirements for integrating different kinds of devices into heterogeneous control systems.

Figure 1 shows how IEC 62453-306 is aligned in the structure of the IEC 62453 series.

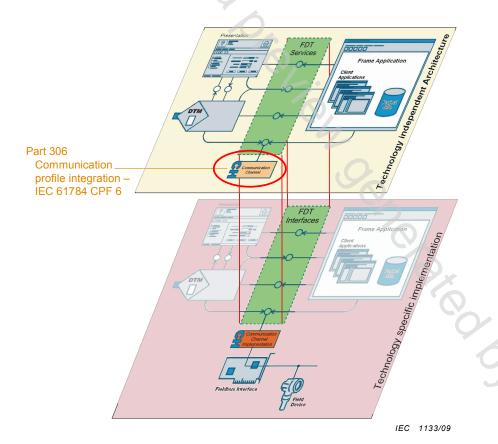


Figure 1 - Part 306 of the IEC 62453 series

## FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION -

# Part 306: Communication profile integration – IEC 61784 CPF 6

### 1 Scope

Communication Profile Family 6 (commonly known as INTERBUS®¹) defines communication profiles based on IEC 61158-2 Type 8, IEC 61158-3-8, IEC 61158-4-8, IEC 61158-5-8, and IEC 61158-6-8. The basic profiles CP 6/1 (INTERBUS) and CP 6/3 (INTERBUS minimal subset) are defined in IEC 61784-1.

This part of IEC 62453 provides information for integrating the INTERBUS® technology into the FDT standard (IEC 62453-2).

This part of the IEC 62453 specifies communication and other services.

This standard neither contains the FDT specification nor modifies it.

#### 2 Normative references

The following referenced documents are indispensable for the application of this specification. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies

IEC 61158-2, Industrial communication networks – Fieldbus specifications – Part 2: Physical layer specification and service definition

IEC 61158-3-8, Industrial communication networks – Fieldbus specifications – Part 3-8: Datalink layer service definition – Type 8 elements

IEC 61158-4-8, Industrial communication networks – Fieldbus specifications – Part 4-8: Datalink layer protocol specification – Type 8 elements

IEC 61158-5-8, Industrial communication networks – Fieldbus specifications – Part 5-8: Application layer service definition – Type 8 elements

IEC 61158-6-8, Industrial communication networks – Fieldbus specifications – Part 6-8: Application layer protocol specification – Type 8 elements

IEC 61784-1, Industrial communication networks - Profiles - Part 1: Fieldbus profiles

IEC 62453-1:2009, Field Device Tool (FDT) interface specification – Part 1: Overview and guidance

IEC 62453-2:2009, Field Device Tool (FDT) interface specification – Part 2: Concepts and detailed description

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